

STP08IE120F4

Preliminary Data

General features

V _{CS(ON)}	۱ _C	R _{CS(ON)}
0.8 V	8 A	0.10 Ω

- High voltage / high current Cascode configuration
- Low equivalent on resistance
- very fast-switch up to 150 kHz
- Squared RBSOA up to 1200V
- Very low C_{iss} driven by $R_G = 47\Omega$
- Very low turn-off cross over time

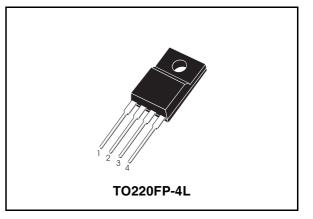
Applications

■ Aux SMPS for three phase mains

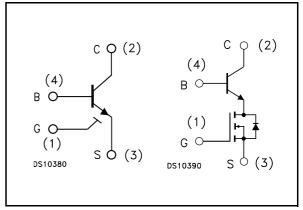
Description

The STP08IE120F4 is manufactured in Monolithic ESBT Technology, aimed to provide best performances in high frequency / high voltage applications.

It is designed for use in Gate Driven based topologies.



Internal schematic diagrams



Order codes

Part Number	Marking	Package	Packing
STP08IE120F4	P08IE120F4	TO220FP-4L	Tube

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Electrical ratings

Table 1. Absolute maximum rating	Table 1.	Absolute maximum rating
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Symbol	Parameter	Value	Unit	
V _{CS(SS)}	Collector-source voltage ($V_{BS} = V_{GS} = 0 V$)	1200	V	
V _{BS(OS)}	Base-source voltage ($I_C = 0$, $V_{GS} = 0$ V)	30	V	
V _{SB(OS)}	Source-base voltage ($I_C = 0$, $V_{GS} = 0$ V)	17	V	
V _{GS}	Gate-source voltage	± 17	V	
۱ _C	Collector current	8	Α	
I _{CM}	Collector peak current (t _P < 5ms)	24	Α	
۱ _B	Base current	6	A	
I _{BM}	Base peak current (t _P < 5ms)	12	A	
P _{tot}	Total dissipation at $T_c = 25^{\circ}C$	21	W	
T _{stg}	Storage temperature	-40 to 150	°C	
Т _Ј	Max. operating junction temperature	150	°C	

Table 2. Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case max	6	°C/W



2 Electrical characteristics

($T_{case} = 25^{\circ}C$ unless otherwise specified)

Table 3.	Electrical characteris	STICS				
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
I _{CS(SS)}	Collector-source current $(V_{BS} = V_{GS} = 0)$	V _{CE} = 1200V			100	μA
I _{BS(OS)}	Base-source current $(I_{C} = 0, V_{GS} = 0)$	$V_{\rm RS}(\infty) = 30V$			10	μA
I _{SB(OS)}	Source-base current $(I_C = 0, V_{GS} = 0)$	V _{SB(OS)} = 17V			100	μA
I _{GS(OS)}	Gate-source leakage	$V_{GS} = \pm 17V$			100	nA
V _{CS(ON)}	Collector-source ON voltage	$V_{GS} = 10V$ $I_C = 8A$ $I_B = 1.6A$ $V_{GS} = 10V$ $I_C = 4A$ $I_B = 0.4A$		0.8 0.5	1 1.2	V V
h _{FE}	DC current gain	$\begin{array}{ll} V_{GS} = 10V & I_C = 8A & V_{CS} = 1V \\ V_{GS} = 10V & I_C = 4A & V_{CS} = 1V \end{array}$	5 7			
V _{BS(ON)}	Base Source ON voltage	$V_{GS} = 10V I_C = 8A I_B = 1.6A$ $V_{GS} = 10V I_C = 4A I_B = 0.4A$		1.5 1.5		V V
V _{GS(th)}	Gate threshold voltage	$V_{BS} = V_{GS}$ $I_B = 250 \mu A$	2	3	4	V
C _{ISS}	Input capacitance	$V_{CS} = 25V$ f = 1MHz $V_{GS} = 0$		550		pF
Q _{GS(tot)}	Gate-source charge	V _{GS} = 10V		26		nC
t _s t _f	INDUCTIVE LOAD Storage time Fall time	$\begin{split} I_C &= 4A I_B = 0.8A \ V_{GS} = 10V \\ V_{Clamp} &= 960V R_G = 47\Omega \\ t_p &= 4\mu s \end{split}$		670 15		ns ns
t _s t _f	INDUCTIVE LOAD Storage time Fall time	$I_{C} = 4A I_{B} = 0.4A V_{GS} = 10V$ $V_{Clamp} = 960V R_{G} = 47\Omega$ $t_{p} = 4\mu s$		340 10.2		ns ns
V _{CSW}	Maximum collector- source voltage switched without snubber	$R_{G} = 47\Omega$ $h_{FE} = 5A$ $I_{C} = 8A$	1200			V
V _{CS(dyn)}	Collector-source dynamic voltage (500ns)	$\begin{split} & V_{\text{CC}} = V_{\text{Clamp}} = 400V \ V_{\text{GS}} = 10V \\ & R_{\text{G}} = 47\Omega I_{\text{C}} = 4A I_{\text{B}} = 0.8A \\ & I_{\text{Bpeak}} = 4A t_{\text{peak}} = 500ns \end{split}$		5.75		V
V _{CS(dyn)}	Collector-source dynamic voltage (1 μs)	$\begin{split} & V_{CC} = V_{Clamp} = 400V \ V_{GS} = 10V \\ & R_{G} = 47\Omega I_{C} = 4A I_{B} = 0.8A \\ & I_{Bpeak} = 4A t_{peak} = 500ns \end{split}$		3.35		V

 Table 3.
 Electrical characteristics



T_J =100 °C

T_J =25 °C

I_c (A)

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Electrical characteristics (curves) 2.1

Output characteristics Figure 1.

Figure 2. DC current gain

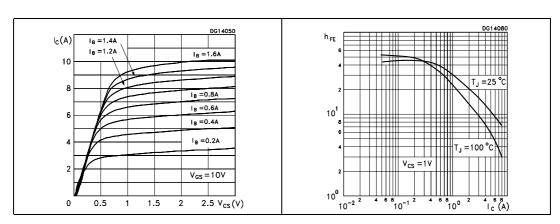


Figure 3. Collector-source On voltage Figure 4. **Collector-source On voltage**

V_{CS(on)} (V)

10¹

10⁰

10-1

10⁻²

10-1

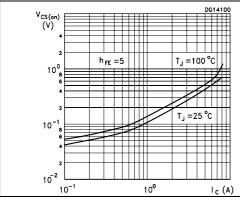


Figure 5.

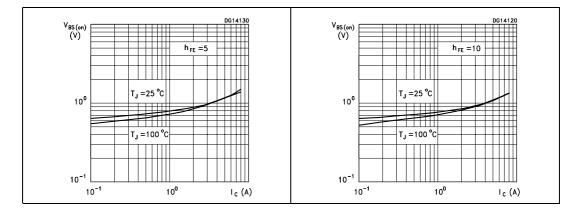
Base-source On voltage

Figure 6. **Base-source On voltage**

h_{FE} = 10

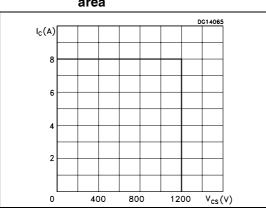
₩

10⁰



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Figure 7.



Reverse biased safe operting Figure 8. Gate threshold voltage vs area temperature

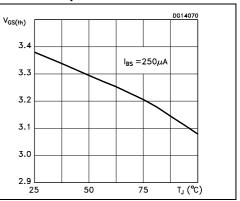
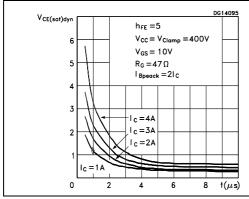
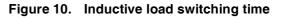


Figure 9. Dynamic collector-emitter saturation voltage





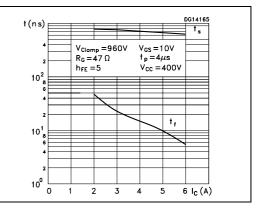
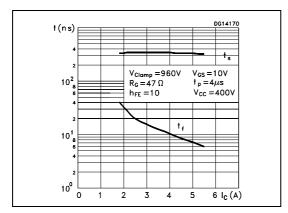


Figure 11. Inductive load switching time





2.2 Test circuits

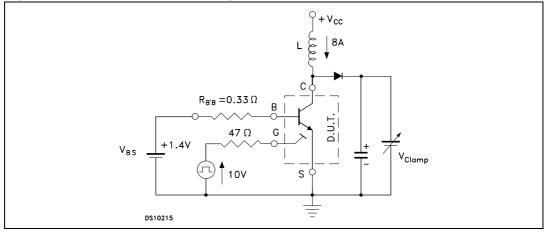


Figure 12. Inductive load switching and RBSOA test circuit

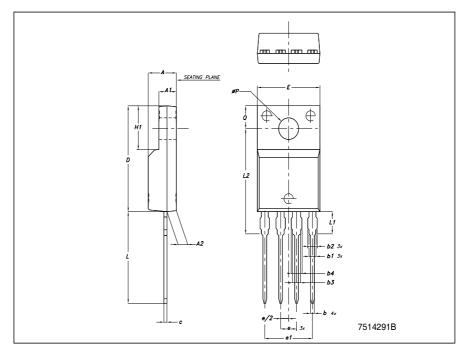
3 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com



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		P-4L MECHANICAL DA	
DIM.		mm.	
	MIN.	¦ TYP	MAX.
A	4.30	[4.70
A1	2.60		3
A2	1.30	1.50	1.70
b	0.50		0.70
b1 ¦	1.05		
b2		·	1.3
b3	1.25		
b4		r	1.50
c	0.45	0.50	0.60
D	15.50		15.90
E	9.80	·	10.20
e	2.29	2.54	2.79
e1		7.62	
-H1	6.30	+	6.70
L :		13.60	
L1		3.30	!
L2	15.40		15.80
Dia P	3	r	3.40
Q	3.30	+	3.50





4 Revision history

Date	Revision	Changes
28-Nov-2006	1	Initial release.

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